

DETAILED DESCRIPTION

[0019] The following description is presented to enable any person skilled in the art to make and use the invention as claimed and is provided in the context of the particular examples discussed below (touch pad input devices for personal computer systems), variations of which will be readily apparent to those skilled in the art. Accordingly, the claims appended hereto are not intended to be limited by the disclosed embodiments, but are to be accorded their widest scope consistent with the principles and features disclosed herein. By way of example only, force imaging systems in accordance with the invention are equally applicable to electronic devices other than personal computer systems such as computer workstations, mobile phones, hand-held digital assistants and digital control panels for various machinery and systems (mechanical, electrical and electronic).

[0020] Referring to FIG. 1, the general concept of a force detector in accordance with the invention is illustrated as it may be embodied in touch pad device 100. As illustrated, force detector 100 comprises cosmetic layer 105, sense layer 110 (including conductive paths 115 and electrical connector 120), dielectric spring layer 125 (including spatially offset raised structures 130), drive layer 135 (including conductive paths 140 and electrical connector 145) and base or support 150. (It will be understood by those of ordinary skill in the art that connectors 120 and 145 provide unique connections for each conductive trace on layers 110 and 135 respectively.)

[0021] Cosmetic layer 105 acts to protect other elements of the system from ambient conditions (e.g., dust and moisture) and, further, provides a surface through which users interact with detector 100. Conductive paths 115 on sense layer 110 are arranged so that they overlap conductive paths 140 on drive layer 135, thereby forming capacitors whose plates (conductive paths 115 and 140) are separated by sense layer substrate 110, dielectric spring layer 125 and raised structures 130. Dielectric spring layer 125 and raised structures 130 together create a mechanism by which sense layer 110's conductive paths 115 are brought into closer proximity to drive layer 135's conductive paths 140 when a force is applied to cosmetic layer 105. It will be recognized that this change in separation causes the mutual capacitance between sense layer and drive layer conductive paths (115 and 140) to change (increase)—a change indicative of the amount, intensity or strength of the force applied to cosmetic layer 105. Base or support layer 150 provides structural integrity for force detector 100.

[0022] Referring to FIG. 2A, a cross-sectional view of force detector 100 is shown in its unloaded or “no force” state. In this state, the mutual capacitance between sense layer 110 and drive layer 135 conductive paths (115 and 140) results in a steady-state or quiescent capacitance signal (as measured via connectors 120 and 145 in FIG. 1). Referring to FIG. 2B, when external force 200 is applied to cosmetic layer 105, dielectric spring layer 125 is deformed so that sense layer 110 moves closer to drive layer 135. This, in turn, results in a change (increase) in the mutual capacitance between the sense and drive layers—a change that is approximately monotonically related to the distance between the two and, therefore, to the intensity or strength of applied force 200. More specifically, during operation

traces 140 (on drive layer 135) are electrically stimulated one at a time and the mutual capacitance associated with the stimulated trace and each of traces 115 (on sense layer 110) is measured. In this way an image of the strength or intensity of force 200 applied to cosmetic layer 105 is obtained. As previously noted, this change in mutual capacitance may be determined through appropriate circuitry.

[0023] Referring to FIG. 3, a block diagram of force imaging system 300 utilizing force detector touch pad 100 is shown. As illustrated, force imaging system 300 comprises force detector 100 coupled to touch pad controller 305 through connectors 120 (for sense signals 310) and 145 (for drive signals 315). Touch pad controller 305, in turn, periodically sends signals to host processor 320 that represent the (spatial) distribution of force applied to detector 100. Host processor 320 may interpret the force information to perform specified command and control actions (e.g., select an object displayed on display unit 325).

[0024] Referring to FIG. 4, during operation drive circuit 400 in touch pad controller 305 sends (“drives” a current through drive signals 315 and connector 145 to each of the plurality of drive layer conductive paths 140 (see FIG. 1) in turn. Because of capacitive coupling, some of this current is carried through to each of the plurality of sense layer conductive paths 115 (see FIG. 1). Sensing circuits 405 (e.g., charge amplifiers) detect the analog signal from sense signals 310 (via connector 120) and send them to analysis circuit 410. One function of analysis circuit 410 is to convert the detected analog capacitance values to digital form (e.g., through A-to-D converters). Another function of analysis circuit is to queue up a plurality of digitized capacitance values for transmission to host processor 320 (see FIG. 3). Yet another function of analysis circuit is to control drive circuit 400 and, perhaps, to dynamically adjust operation of sense circuits 405 (e.g., such as by changing the threshold value at which a “change” in capacitance is detected). One embodiment of controller 305 suitable for use in the present invention is described in US patent application entitled “Multipoint Touch Screen Controller,” Ser. No. 10/999,999 by Steve Hotelling, Christoph Krah and Brian Huppi, filed 15 Mar. 2006 and which is hereby incorporated in its entirety.

[0025] In another embodiment, a force detector in accordance with the invention is combined with a capacitive location detector to create a touch pad device that provides both location and force detection. Referring to FIG. 5, combined location and force detector 500 comprises cosmetic layer 505, circuit board or substrate 510 (including a first plurality of conductive drive paths 515 on a first surface and a plurality of sense paths 520 on a second surface), dielectric spring layer 525 (including alternating, or spatially offset, raised structures 530), drive layer 535 (including a second plurality of conductive drive paths) and base or support 540. In one embodiment, conductive drive paths 515 and 535 are laid down on substrate 510 and support 540 respectively to form rows and sense conductive paths are laid down on substrate 510 to form columns. Accordingly, during operation first drive paths 515 are driven (one at a time) during a first time period and, during this same time, sense paths 520 are interrogated to obtain an image representing the location of one or more cosmetic layer touches. Similarly, second drive paths 535 are driven (one at a time) during a second time period and, during this same time,